

MODEL NO. : _	TM024HDH63	
SSUED DATE: _	2010-12-6	
VERSION :	Ver 1.0	

■Preliminary Specification
□Final Product Specification

Customer: WINTECH

Approved by	Notes

SHANGHAI TIANMA Confirmed:

Prepared by	Checked by	Approved by

This technical specification is subjected to change without notice.



Table of Contents

Cov	/ersheet	 1
Tab	le of Contents	2
Red	cord of Revision	 3
1	General Specifications	a. 4
2	Input/Output Terminals	5
3	Absolute Maximum Ratings	7
4	Electrical Characteristics	8
5		
6		
7		. 22
8		. 22
9		
_		25



Record of Revision

Rev	Issue Date	Description	Editor
1.0	2010-12-6	Preliminary release.	Rongguo Hong
	A		



1 General Specifications

	Feature	Spec	
	Size	2.4 inch	
	Resolution	240(RGB) x 320	
	Interface	CPU 8/9/16/18 bits	
	Color Depth	262k	
	Technology Type	a-Si	
Display Spec	Pixel Pitch (mm)	0.153x 0.153	
	Pixel Configuration	R.G.B Vertical Stripe	
	Display Mode	TM with Normally White	
	Surface Treatment	Clear Type	
	Viewing Direction	6 o'clock	
	Gray Scale Inversion Direction	12 o'clock	
	LCM (W x H x D) (mm)	42.72x60.26x2.25	
	Active Area(mm)	36.72 x 48.96	
Mechanical Characteristics	With /Without TSP	Without TSP	
Onaracteristics	Weight (g)	TBD	
	LED Numbers	3 LEDs	
Electronic	Driver IC	HX8347G	

Note 1: Viewing direction for best image quality is different from TFT definition, there is a 180 degree shift.

Note 2: Requirements on Environmental Protection: RoHS.

Note 3: LCM weight tolerance: +/- 5%.



2 Input/Output Terminals

2.1 TFT LCD Panel

No	Symbol	I/O	Description	Remark
1	GND	Р	Power Ground	
2	Y-	-	No connection	
3	X-	-	No connection	A
4	Y+	-	No connection	
5	X+	-	No connection	
6	GND	Р	Power Ground	
7	IM0		Mode select	Note 4-2
8	IM3	_	Mode select	Note 4-2
9	NC	ı	No connection	
10	NC	ı	No connection	
11	LCD_ID	0	LCD identify for reading a 0.0173Volt Voltage	
12	RESET		Reset signal	
13	D9	-	Data Input	
14	D0		Data Input	
15	D17	Ι	Data Input	
16	D16		Data Input	
17	D15	_	Data Input	
18	D14		Data Input	
19	D13	1	Data Input	
20	D12	I	Data Input	
21	D11	1	Data Input	
22	D10		Data Input	
23	D8		Data input	
24	D7		Data input	
25	D6		Data input	
26	D5		Data input	
27	D4	I	Data input	
28	D3	I	Data input	
29	D2	I	Data input	
30	D1	I	Data input	
31	RD	I	Read	
32	WR	1	Write	
33	RS	I	Register select	
34	CS	I	Chip select	
35	GND	Р	Ground	



TIANMA MICRO-ELECTRONICS

TM024HDH63 V1.0

36	IOVCC	Р	Power Supply of Logic Circuit	
37	VCC	Р	Power Supply of Analog Circuit	
38	VCC	Р	Power Supply of Analog Circuit	
39	NC	-	No connection	
40	LEDK3	Р	LED cathode	
41	LEDK2	Р	LED cathode	
42	LEDK1	Р	LED cathode	
43	LEDA	Р	LED anode	
44	GND	Р	Ground	

Note 4-1: I/O definition: I-----Input; O---Output; P----Power/Ground.

Note 4-2:

IM3	IMO	Interfece	Data B	us Use
		Interface	Register/Content	GRAM
0	0	8080 MCU 16bit parallel	D8~D1	D17~D10,D8~D1
0	1	8080 MCU 8bit parallel	D17~D10	D17~D10
1	0	8080 MCU 18bit parallel	D8~D1	D17~D0
1	1	8080 MCU 9bit parallel	D17~D10	D17~D9



3 Absolute Maximum Ratings

3.1 Driving TFT LCD Panel

GND=0V, Ta=25°C

Item	Symbol	Min	Max	Unit	Remark
Logic Supply Voltage	IOVCC	-0.3	4.6	٧	_
Analog Supply Voltage	VCC	-0.3	4.6	٧	
Input Signal Voltage	RESET,CS,RS,WR,RD D0~D17,IM0,IM3	-0.3	IOVCC +0.5	V	
Back Light Forward Current	Vtp	1	7.0	>	
Operating Temperature	I _{LED}	-	25	mA	For each LED
Storage Temperature	T_OPR	-20	70	$^{\circ}\!\mathbb{C}$	



4 Electrical Characteristics

4.1 Driving TFT LCD Panel

GND=0V, Ta=25°C

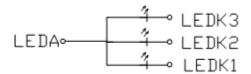
Iten	1	Symbol	Min	Тур	Max	Unit	Remark
Logic Supply	y Voltage	IOVCC	1.65	1.8/2.8	3.3	V	
Analog S Voltag		VCC	2.3	2.8	3.3	V	
Input Signal	Low Level	V_{IL}	0		0.2xIOVCC	V	RESET,CS,RS,WR,RD
Voltage	High Level	V_{IH}	0.8xIOVCC		IOVCC	V	D0~D17,IM0,IM3
Output	Low Level	Vol	0	-	0.2xIOVCC	V	100.10
Signal Voltage	High Level	Vон	0.8xIOVCC	1	IOVCC	٧	LCD_ID
		Black Mode		TBD		mW	Frame Rate:60Hz
(Panel+ LSI) Power Consumption		Standby Mode	1	TBD		μW	
		Sleeping Mode		TBD		μW	

4.2 Driving Backlight

Ta=25°C

Item	Symbol	Min	Тур	Max	Unit	Remark
Forward Current	I _F		20		mA	For each LED
Forward Voltage	V_{F}		3.2		V	
Power Consumption	W_{BL}		192		mW	
Operating Life Time		10000	(20000)	-	Hrs	

Note 1: The figure below shows the connection of backlight LED.



Note 2: One LED: $I_F = 20mA$, $V_F = 3.2V$.

Note 3:

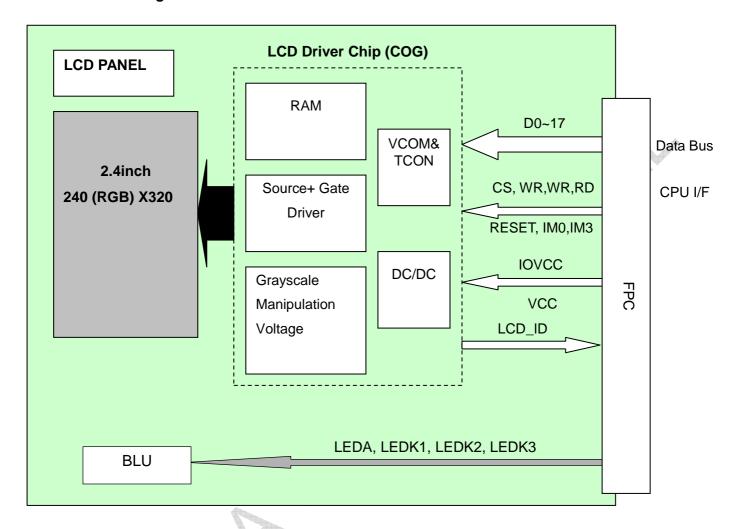
I_F is defined for one channel LED.

Optical performance should be evaluated at Ta=25°C only.

If LED is driven by high current, high ambient temperature & humidity condition. The life time of LED will be reduced.

Operating life means brightness goes down to 50% initial brightness. Typical operating life time is estimated data.

4.3 Block Diagram



5 Timing Chart

5.1 Timing Parameter

(VSSA=0V, IOVCC=1.65V to 3.3V, VCI=2.3V to $3.3V, T_A = -30$ to 70° C)

Cianal	Symbol	Parameter		Spec.		Unit	Description
Signal	Symbol	rarameter	Min.	Тур	Max.	Oill	Description
RS	tAST tAHT	Address setup time Address hold time (Write/Read)	10 10	-	-	ns	-
cs	tCHW tCS tRCS tRCSFM tCSF tCSH	Chip select "H" pulse width Chip select setup time (Write) Chip select setup time (Read ID) Chip select setup time (Read FM) Chip select wait time (Write/Read) Chip select hold time	0 15 45 355 10 10		1 1 1 1 1	ns	-
WR	tWC tWRH tWRL	Write cycle Control pulse "H" duration Control pulse "L" duration	66 15 15	1 1	30	ns	<u>-</u>
RD	tRC tRDH tRDL	Read cycle (ID) Control pulse "H" duration (ID) Control pulse "L" duration (ID)	160 90 45	- <	<i>i</i>	ns	When read ID data
RD(FM)	tRCFM tRDHFM tRDLFM	Read cycle (FM) Control pulse "H" duration (FM) Control pulse "L" duration (FM)	450 90 355	(Š)		ns	When read from frame memory
D[17:0]	tDST tDHT tRAT tRATFM tODH	Data setup time Data hold time Read access time (ID) Read access time (FM) Output disable time	10 10 - 20) ((100 340 80	ns	For maximum CL=30pF For minimum CL=8pF

Note: The input signal rise time and fall time (tr, tf) is specified at 15 ns or less.

Logic high and low levels are specified as 30% and 70% of IOVCC for Input signals.

Table 5.1 Timing Parameter

Refer to the HX-8347G datasheet(HX8347-G_DS_T_preliminary_v01) for more details.



5.2 Register Write/Read timing (for CPU 8 Bit)

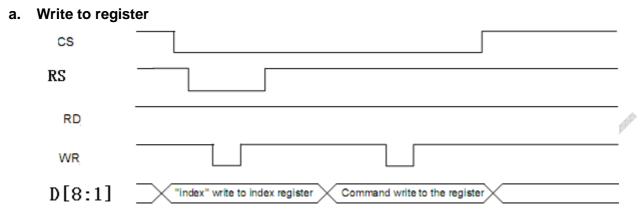


Figure 5.1 Register write timing in parallel bus system interface (for I80 series MPU)

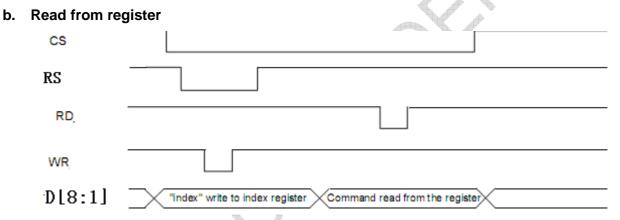


Figure 5.2 Register read timing in parallel bus system interface (for I80 series MPU)

5.3 GRAM write timing in i80 8/16bit system

Register	DB17	DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Command	
Command	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	0	0	1	0	0	0	1	0	22H	
17H	DB17	DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Color	
	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	R3	R2	R1	R0	G3	G2	G1	G0	4K-Color	
03h	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	В3	B2	B1	B0	R3	R2	R1	R0	(2-pixels/ 3-bytes)	
	Х	Х	Х	Х	Χ	Х	Х	Х	Х	Х	G3	G2	G1	G0	В3	B2	B1	B0	(E pixolo, o bytoo)	
05h	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	R4	R3	R2	R1	R0	G5	G4	G3	65K-Color	
0311	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	G2	G1	G0	B4	В3	B2	B1	B0	(1-pixel/ 2-bytes)	
	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	R5	R4	R3	R2	R1	R0	Х	Х	262K-Color	
06h	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	G5	G4	G3	G2	G1	G0	х	х	(1-pixel/ 3bytes)	
	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	B5	B4	В3	B2	B1	B0	х	х	(Pinos objeco)	

Table 5.2 8 bit parallel interface GRAM write table

Register	DB17	DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Command	
Command	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	0	0	1	0	0	0	1	0	22H	
17H	DB17	DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Color	
03h							R3	R2	R1	R0	G3	G2	G1	G0	В3	B2	B1	B0	4K-Color	
05h	Х	Х	R4	R3	R2	R1	R0	G5	G4	G3	G2	G1	G0	B5	B4	В3	B2	B1	65K-Color	
	Х	Х	R5	R4	R3	R2	R1	R0	Х	Х	G5	G4	G3	G2	G1	G0	х	Х	2021/ 0-1	
06h	Х	Х	B5	B4	В3	B2	B1	В0	х	х	R5	R4	R3	R2	R1	R0	х	х	262K-Color (2-pixels/ 3bytes)	
	Х	Х	G5	G4	G3	G2	G1	G0	х	Х	B5	B4	В3	B2	B1	B0	х	х	(2-pixelar abytes)	
07h	Х	Х	R5	R4	R3	R2	R1	R0	G5	G4	G3	G2	G1	G0	B5	B4	В3	B2	262K-Color (16+2)	
0711	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	X	Х	B1	B0	2021(-00101 (1012)	

Table 5.3 16 bit parallel interface GRAM write table

						607		400000000											
Register	DB17	DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Register
Command	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	0	0	1	0	0	0	1	0	22H
17H	DB17	DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Color
06h	Х	Х	Х	Х	Х	Х	Х	Х	Х	R5	R4	R3	R2	R1	R0	G5	G4	G3	262K-Color
0011	Х	Х	Х	Х	Х	Х	Х	Х	х	G2	G1	G0	B5	B4	В3	B2	B1	В0	(1-pixels/ 2bytes)

Table 5.4 9 bit parallel interface GRAM write table

	-	-	ana, or		2.75		e e					-							
Register	DB17	DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Register
Command	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	0	0	1	0	0	0	1	0	22H
17H	DB17	DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Color
06h	R5	R4	R3	R2	R1	R0	G5	G4	G3	G2	G1	G0	B5	B4	В3	B2	B1	B0	262K-Color

Table 5.5 18 bit parallel interface GRAM write table

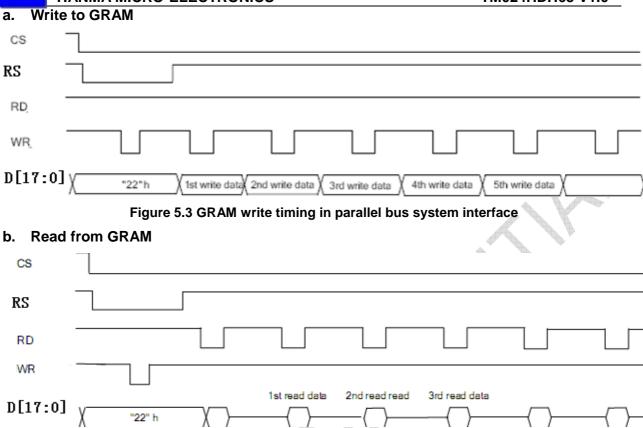
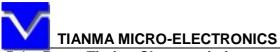


Figure 5.4 GRAM read timing in parallel bus system interface



5.4 Reset Timing Characteristics

Item	Symbol	Unit	Min	Тур	Max
RESET low pulse width	t _{RESW}	μs	10		
Reset complete time(STB out mode)	t _{rREST}	ms	5		
Reset complete time(STB mode)	tres	ms	120		
Reset goes high lever after power on time	tres	ms	1		

Table 5.4 RESET Timing Parameter

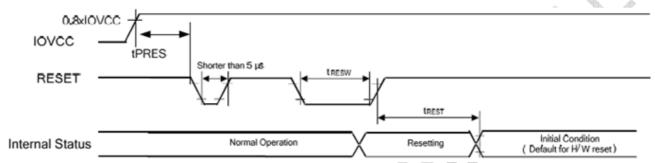
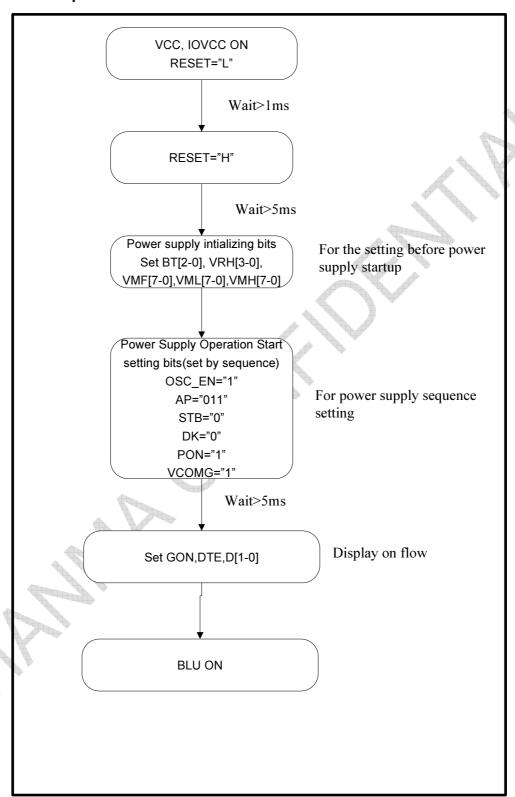


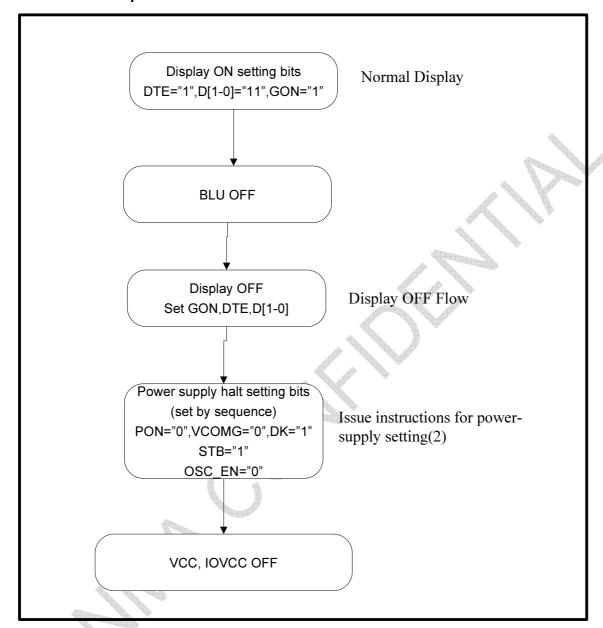
Figure 5.4 RESET Timing

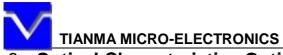
5.5 Power ON/OFF Sequence

5.5.1 Power ON Sequence



5.5.2 Power OFF Sequence





Optical Characteristics Optical Specification

Ta=25°C

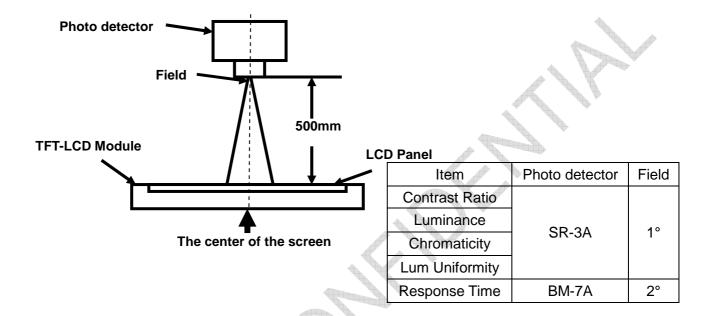
Item	1	Symbol	Condition	Min	Тур	Max	Unit	Remark	
		θТ		60	70				
Niou Anglo		θВ	CR≥10	50	60		Dograd	Note 2	
View Angle		θL	UR210	60	70		Degree	Note 2	
		θR		60	70		4		
Contrast Ratio)	CR	θ=0°	400	400 500			Note1 Note3	
Response Tim	10	T _{ON}	25 ℃		20	30	ms	Note1	
iveshouse un	. <u>.</u>	T_{OFF}	25 0		20	30	1113	Note4	
	White	Х		0.239	0.289	0.339			
	vviile	у		0.265	0.315	0.365			
	Red	Х		0.538	0.588	0.638			
Chromaticity		у	Backlight is	0.294	0.344	0.394		Note1	
Critornationy	Green	Х	on	0.273	0.323	0.373		Note5	
	Green	у		0.535	0.585	0.635			
	Blue	Х		0.098	0.148	0.198			
	Dide	у		0.055	0.105	0.155			
Uniformity (%)		U			80			Note1 Note6	
NTSC (%)					50			Note5	
Luminance				200	225			Note1 Note7	

Test Conditions:

- 1. $V_F = 3.2V$, $I_F = 20$ mA(LED current), the ambient temperature is 25°C.
- 2. The test systems refer to Note1 and Note2.

Note 1: Definition of optical measurement system.

The optical characteristics should be measured in dark room. After 5 minutes operation, the optical properties are measured at the center point of the LCD screen. All input terminals LCD panel must be ground when measuring the center area of the panel.



Note 2: Definition of viewing angle range and measurement system.

viewing angle is measured at the center point of the LCD by CONOSCOPE(ergo-80).

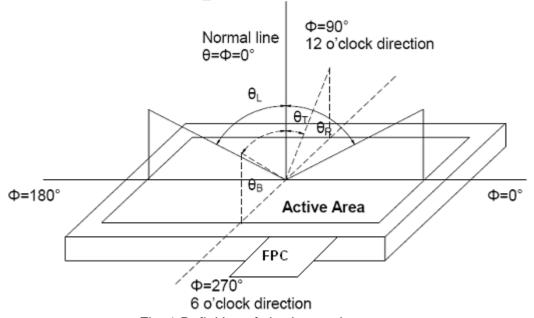


Fig. 1 Definition of viewing angle

Note 3: Definition of contrast ratio

Contrast ratio (CR) =
\[
\frac{\text{Luminance measured when LCD is on the "White" state}}{\text{Luminance measured when LCD is on the "Black" state}}
\]

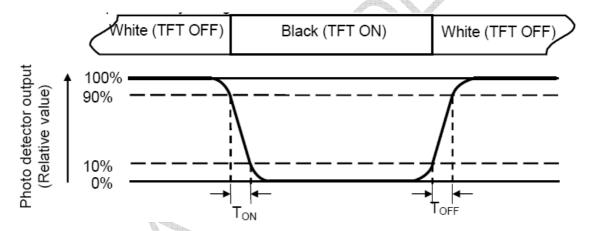
"White state ": The state is that the LCD should driven by Vwhite.

"Black state": The state is that the LCD should driven by Vblack.

 V_{white} : To be determined V_{black} : To be determined.

Note 4: Definition of response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (T_{ON}) is the time between photo detector output intensity changed from 90% to 10%. And fall time (T_{OFF}) is the time between photo detector output intensity changed from 10% to 90%.



Note 5: Definition of color chromaticity (CIE1931)

Color coordinates measured at center point of LCD.

Note 6: Definition of luminance uniformity

Active area is divided into 9 measuring areas (Refer Fig. 2). Every measuring point is placed at the center of each measuring area.

Luminance Uniformity(U) = Lmin/Lmax

L----- Active area length W----- Active area width

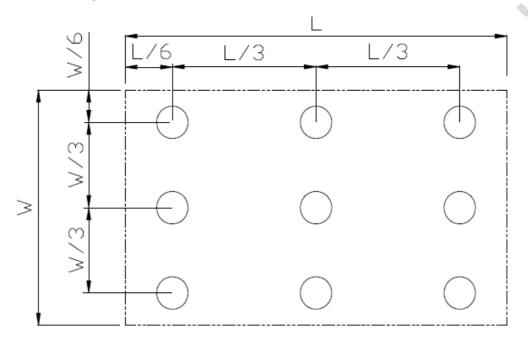


Fig. 2 Definition of uniformity

Lmax: The measured maximum luminance of all measurement position.

Lmin: The measured minimum luminance of all measurement position.

Note 7: Definition of luminance:

Measure the luminance of white state at center point.



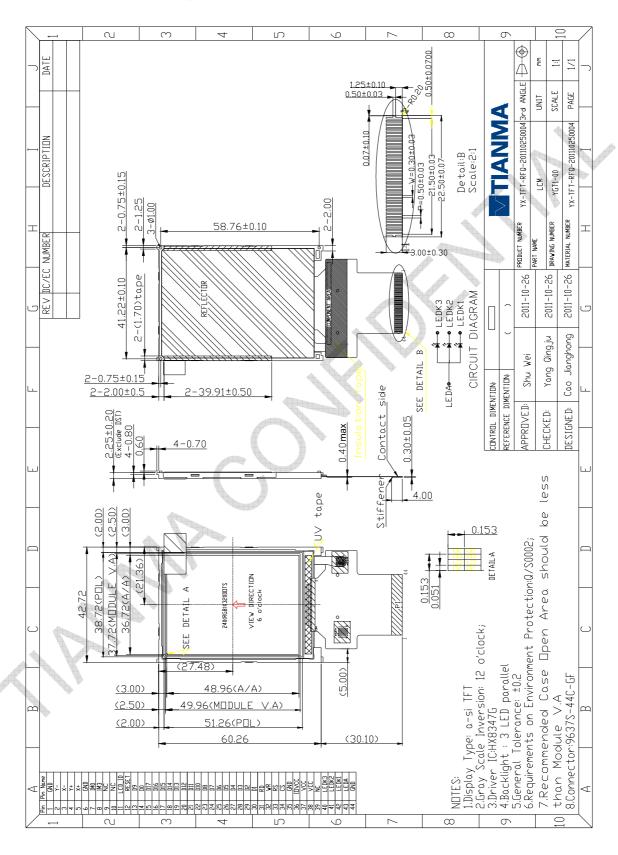
7 Environmental / Reliability Test

No	Test Item	Condition	Remark
1	High Temperature Operation	Ts=+70℃, 240hrs	Note1 IEC60068-2-1,GB2423.2
2	Low Temperature Operation	Ta=-20℃, 240hrs	IEC60068-2-1 GB2423.1
3	High Temperature Storage	Ta=+80℃, 240hrs	IEC60068-2-1 GB2423.2
4	Low Temperature Storage	Ta=-30℃, 240hrs	IEC60068-2-1 GB2423.1
5	High Temperature & High Humidity Storage	Ta=+60℃, 90% RH 240 hours	Note2 IEC60068-2-78 GB/T2423.3
6	Thermal Shock (Non-operation)	-30℃ 30 min~+80℃ 30 min, Change time:5min, 20 Cycles	Start with cold temperature, End with high temperature, IEC60068-2-14,GB2423.22
7	Electro Static Discharge (Operation)	C=150pF, R=330 Ω , 5points/panel Air:±8KV, 5times; Contact:±4KV, 5 times; (Environment: 15 $^{\circ}$ C-35 $^{\circ}$ C, 30%~60%, 86Kpa~106Kpa).	IEC61000-4-2 GB/T17626.2
8	Vibration (Non-operation)	Frequency range:10~55Hz, Stroke:1.5mm Sweep:10Hz~55Hz~10Hz 2 hours for each direction of X.Y.Z. (6 hours for total)(Package condition)	IEC60068-2-6 GB/T2423.10
9	Shock (Non-operation)	60G 6ms, ±X,±Y,±Z 3times, for each direction	IEC60068-2-27 GB/T2423.5
10	Package Drop Test	Height:80 cm,1 corner, 3 edges, 6 surfaces	IEC60068-2-32 GB/T2423.8
11	Package Vibration Test	Random Vibration: 0.015GxG/Hz for 5-200Hz, -6dB/Octave from 200-500Hz 2 hours for each direction of X,Y,Z (6 hours for total)	IEC60068-2-34 GB/T2423.11

Note1: Ts is the temperature of panel's surface.

Note2: Ta is the ambient temperature of sample.

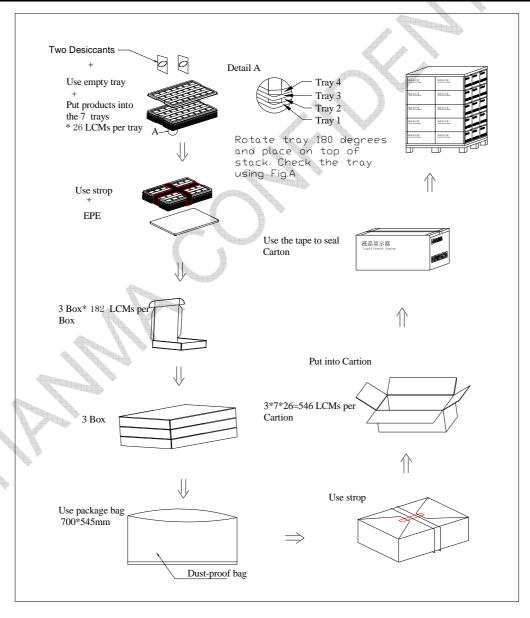
8 Mechanical Drawing





9 Packing Drawing

No	Item	Model (Material)	Dimensions(mm)	Unit Weight(Kg)	Quantity	Remark
1	LCM module	TM024HDH63	42.72x60.26x2.25	TBD	TBD	
2	Tray	PET(Transmit)	TBD	TBD	TBD	
3	EPE	EPE	TBD	TBD	TBD	
4	Desiccant	Desiccant	TBD	TBD	TBD	
5	Anti-static bag	PE	TBD	TBD	TBD	
6	BOX	Corrugated paper	TBD	TBD	TBD	
7	Carton	Corrugated paper	TBD	TBD	TBD	
8	Total Weight(Kg)		TBD			





10 Precautions for Use of LCD Modules

- 10.1 Handling Precautions:
- 10.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 10.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 10.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 10.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 10.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
 - Isopropyl alcohol
 - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- Aromatic solvents
- 10.1.6 Do not attempt to disassemble the LCD Module.
- 10.1.7 If the logic circuit power is off, do not apply the input signals.
- 10.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
- 10.1.8.1 Be sure to ground the body when handling the LCD Modules.
- 10.1.8.2 Tools required for assembly, such as soldering irons, must be properly ground.
- 10.1.8.3 To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
- 10.1.8.4 The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.
- 10.2 Storage precautions:
- 10.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 10.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:
- 10.2.3 Temperature: 0°C~40°C Relatively humidity: ≤80%
- 10.2.4 The LCD modules should be stored in the room without acid, alkali and harmful gas.
- 10.3 Transportation Precautions:
 - The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.